TAIWAN SEMICONDUCTOR

RoHS COMPLIANCE

Preliminary

TSM4392

30V N-Channel MOSFET

SOP-8

Pin Definition:
1. Source
2. Source
3. Source
4. Gate
5, 6, 7, 8. Drain

PRODUCT SUMMARY

V_{DS} (V)	$R_{DS(on)}$(mΩ)	I_D (A)
30	11.5 @ V_{GS} = 10V	12.5
	16.5 @ V_{GS} = 4.5V	10

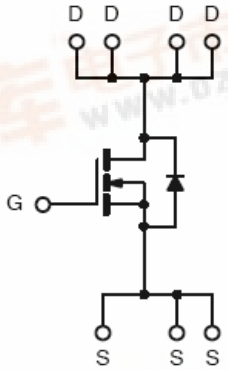
Features

- Advance Trench Process Technology
- High Density Cell Design for Ultra Low On-resistance

Application

- High-Side DC/DC Conversion
- Notebook
- Sever

Block Diagram



N-Channel MOSFET

Ordering Information

Part No.	Package	Packing
TSM4392CS RL	SOP-8	2.5Kpcs / 13” Reel

Absolute Maximum Rating (Ta = 25°C unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current		I_D	12.5	A
Pulsed Drain Current		I_{DM}	50	A
Continuous Source Current (Diode Conduction)[a,b]		I_S	2.7	A
Maximum Power Dissipation	Ta = 25°C	P_D	3.0	W
	Ta = 75°C		1.9	
Operating Junction Temperature		T_J	+150	°C
Operating Junction and Storage Temperature Range		T_J, T_{STG}	- 55 to +150	°C

Thermal Performance

Parameter	Symbol	Limit	Unit
Junction to Case Thermal Resistance	$R\Theta_{JF}$	25	°C/W
Junction to Ambient Thermal Resistance (PCB mounted)	$R\Theta_{JA}$	50	°C/W

Notes:

a. Pulse width limited by the Maximum junction temperature

b. Surface Mounted on FR4 Board, t ≤ 10 sec.

TAIWAN SEMICONDUCTOR

RoHS COMPLIANCE

Preliminary

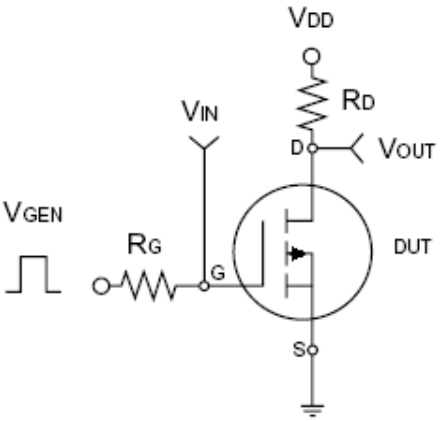
TSM4392

30V N-Channel MOSFET

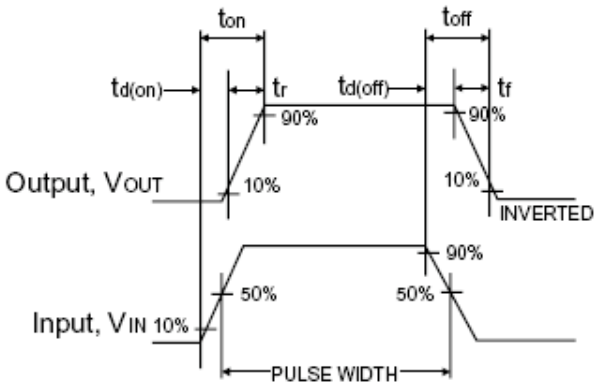
Electrical Specifications (Ta = 25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250uA	BV_{DSS}	30	--	--	V
Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	$V_{GS(TH)}$	1	1.8	3	V
Gate Body Leakage	V_{GS} = ±20V, V_{DS} = 0V	I_{GSS}	--	--	±100	nA
Zero Gate Voltage Drain Current	V_{DS} = 24V, V_{GS} = 0V	I_{DSS}	--	--	1.0	μA
On-State Drain Current[a]	V_{DS} ≥ 5V, V_{GS} = 10V	$I_{D(ON)}$	30	--	--	A
Drain-Source On-State Resistance[a]	V_{GS} = 10V, I_D = 12.5A	$R_{DS(ON)}$	--	9	11.5	mΩ
	V_{GS} = 4.5V, I_D = 10A		--	13	16.5	
Forward Transconductance[a]	V_{DS} = 15V, I_D = 12.5A	g_{fs}	--	40	--	S
Diode Forward Voltage	I_S = 2.7A, V_{GS} = 0V	V_{SD}	--	0.85	1.3	V
Dynamic[b]						
Total Gate Charge	V_{DS} = 15V, I_D = 12.5A, V_{GS} = 10V	Q_g	--	26	--	nC
Gate-Source Charge		Q_{gs}	--	6	--	
Gate-Drain Charge		Q_{gd}	--	5	--	
Input Capacitance	V_{DS} = 15V, V_{GS} = 0V, f = 1.0MHz	C_{iss}	--	2134	--	pF
Output Capacitance		C_{oss}	--	343	--	
Reverse Transfer Capacitance		C_{rss}	--	134	--	
Switching[c]						
Turn-On Delay Time	V_{DD} = 15V, R_L = 15Ω, I_D = 1A, V_{GEN} = 10V, R_G = 6Ω	$t_{d(on)}$	--	17	--	nS
Turn-On Rise Time		t_r	--	3.5	--	
Turn-Off Delay Time		$t_{d(off)}$	--	40	--	
Turn-Off Fall Time		t_f	--	6	--	

Notes:
a. pulse test: PW ≤300μS, duty cycle ≤2%
b. For DESIGN AID ONLY, not subject to production testing.
b. Switching time is essentially independent of operating temperature.



Switching Test Circuit



Switchin Waveforms

TAIWAN SEMICONDUCTOR

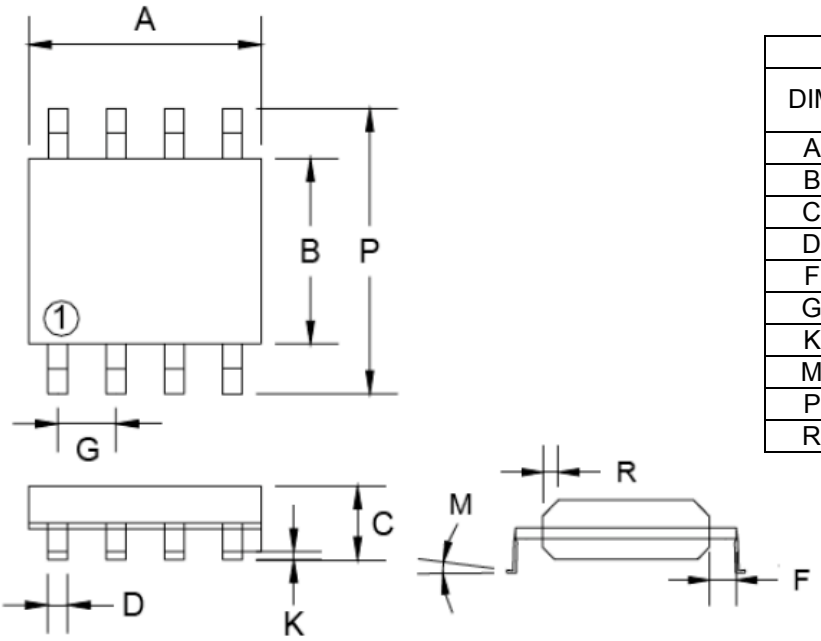
RoHS COMPLIANCE

Preliminary

TSM4392

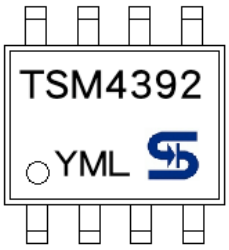
30V N-Channel MOSFET

SOP-8 Mechanical Drawing



SOP-8 DIMENSION				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX.
A	4.80	5.00	0.189	0.196
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27BSC		0.05BSC	
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

Marking Diagram



Y = Year Code

M = Month Code

(**A**=Jan, **B**=Feb, **C**=Mar, **D**=Apl, **E**=May, **F**=Jun, **G**=Jul, **H**=Aug, **I**=Sep, **J**=Oct, **K**=Nov, **L**=Dec)

L = Lot Code

TAIWAN SEMICONDUCTOR

RoHS COMPLIANCE

Preliminary

TSM4392

30V N-Channel MOSFET

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.